Form No. 2 (related to Article 2)

Pledge and Consent Form

To the President of the Japan International Cooperation Agency

I, as the (parent or guardian) of (student applicant’s name), hereby pledge and consent to the following items.

1.　　　　　　　　　　　　　　　　　(student applicant’s name) (the “Applicant”) hereby applies to be a trainee in the Education Program for Nikkei Next Generation of JICA. If accepted, the Applicant will travel to and from Japan to participate in the program.

2. JICA will provide the Applicant with the necessary guidance and supervision for the program and life during the program.

3. If the Applicant suffers injury or damage by a third party for reasons attributable to the Applicant while participating in the program, I am responsible for remedying the situation and paying any expenses required therein.

4. I am responsible for all expenses other than those stipulated in JICA’s rules for participating in the program.

5. After the program is complete, I will ensure that the Applicant returns to their home country according to the prescribed itinerary.

6. I entrust emergency action, medical care, and other matters in the event of unforeseen accidents, injuries, illnesses, and the like to the Applicant during the round-trip travel and the program to JICA and medical facilities designated by JICA. Additionally, I am responsible for any expenses that exceed the coverage of the overseas travel accident insurance purchased in advance for participating in the program.

7. I will provide my contact information to JICA and people involved in the program (e.g. institutions contracted for training, host families) for emergency contact in the event of unforeseen accidents, injuries, illnesses, or other emergencies during the round-trip travel and the program.

8. The establishment and validity of this Pledge and Consent Form and the legal relationship between JICA and me is interpreted and determined in accordance with the laws of Japan.

　　　　　　　　　　　　　　　　　　　　　　　　　　Date: YYYY MM DD

Name of parent or guardian:

Relationship to the Applicant:

Current address: